# imall

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



## Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832 Email & Skype: info@chipsmall.com Web: www.chipsmall.com Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China





## STS8DN3LLH5

## Dual N-channel 30 V, 0.0155 Ω, 10 A, SO-8 STripFET™ V Power MOSFET

### Features

Туре	V <sub>DSS</sub> R <sub>DS(on)</sub> max		I <sub>D</sub>
STS8DN3LLH5	30 V	< 0.019 Ω	10 A <sup>(1)</sup>

- 1. The value is rated according  $R_{thj-pcb}$
- R<sub>DS(on)</sub> \* Q<sub>g</sub> industry benchmark
- Extremely low on-resistance R<sub>DS(on)</sub>
- Very low switching gate charge
- High avalanche ruggedness
- Low gate drive power losses

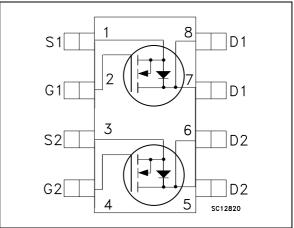
## Application

Switching applications

### Description

This STripFET<sup>™</sup>V Power MOSFET technology is among the latest improvements, which have been especially tailored to achieve very low on-state resistance providing also one of the best-in-class FOM. SO-8

Figure 1. Internal schematic diagram



#### Table 1.Device summary

Order code	Marking	Package	Packaging
STS8DN3LLH5	8DN3LL	SO-8	Tape and reel

## Contents

1	Electrical ratings	3
2	Electrical characteristics	4
	2.1 Electrical characteristics (curves)	6
3	Test circuits	8
4	Package mechanical data	9
5	Revision history1	1



## 1 Electrical ratings

Table 2.	Absolute maxim	um ratings
----------	----------------	------------

Symbol	Parameter	Value	Unit
V <sub>DS</sub>	Drain-source voltage (V <sub>GS</sub> = 0)	30	V
V <sub>GS</sub>	Gate-source voltage	± 22	V
I <sub>D</sub> <sup>(1)</sup>	Drain current (continuous) at $T_C = 25 \ ^{\circ}C$	10	А
I <sub>D</sub> <sup>(1)</sup>	Drain current (continuous) at T <sub>C</sub> =100 °C	9	Α
I <sub>DM</sub> <sup>(2)</sup>	Drain current (pulsed)	40	Α
P <sub>TOT</sub> <sup>(2)</sup>	Total dissipation at $T_C = 25 \ ^{\circ}C$	2.7	W
	Derating factor	0.02	W/°C
T <sub>J</sub> T <sub>stg</sub>	Operating junction temperature Storage temperature	-55 to 150	°C

1. The value is rated according  $R_{thj\text{-}pcb}$ 

2. Pulse width limited by safe operating area

#### Table 3. Thermal resistance

Symbol	Parameter	Value	Unit
R <sub>thj-pcb</sub> <sup>(1)</sup>	Thermal resistance junction-ambient	47	°C/W

1. When mounted on FR-4 board of 1inch<sup>2</sup>, 2oz Cu, t < 10sec



## 2 Electrical characteristics

(T<sub>CASE</sub>=25°C unless otherwise specified)

	On/on states					
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V <sub>(BR)DSS</sub>	Drain-source breakdown voltage	$I_{D} = 250 \ \mu A, \ V_{GS} = 0$	30			V
I <sub>DSS</sub>	Zero gate voltage drain current (V <sub>GS</sub> = 0)	V <sub>DS</sub> = max rating, V <sub>DS</sub> =max rating @125 °C			1 10	μΑ μΑ
I <sub>GSS</sub>	Gate body leakage current (V <sub>DS</sub> = 0)	$V_{GS} = \pm 22 V$			±100	nA
V <sub>GS(th)</sub>	Gate threshold voltage	$V_{DS}$ = $V_{GS}$ , $I_D$ = 250 $\mu$ A	1			V
R <sub>DS(on)</sub>	Static drain-source on resistance	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 5 A V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 5 A		0.0155 0.020	0.019 0.022	Ω Ω

#### Table 4. On/off states

#### Table 5. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C <sub>iss</sub> C <sub>oss</sub> C <sub>rss</sub>	Input capacitance Output capacitance Reverse transfer capacitance	V <sub>DS</sub> = 25 V, f=1 MHz, V <sub>GS</sub> =0	-	724 132 21		pF pF pF
Q <sub>g</sub> Q <sub>gs</sub> Q <sub>gd</sub>	Total gate charge Gate-source charge Gate-drain charge	V <sub>DD</sub> =15 V, I <sub>D</sub> = 10 A V <sub>GS</sub> = 4.5 V <i>Figure 14</i>	-	5.4 2 2.1		nC nC nC
R <sub>G</sub>	Intrinsic gate resistance	f=1 MHz gate dc bias=0 test signal level = 20 mV open drain	-		3.3	Ω



Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t <sub>d(on)</sub> t <sub>r</sub> t <sub>d(off)</sub> t <sub>f</sub>	Turn-on delay time Rise time Turn-off delay time Fall time	$V_{DD}$ =15 V, I <sub>D</sub> = 5 A, R <sub>G</sub> =4.7 Ω, V <sub>GS</sub> =10 V <i>Figure 13</i>	-	4 4.2 21.1 3.5	-	ns ns ns ns

Table 6.Switching times

#### Table 7.Source drain diode

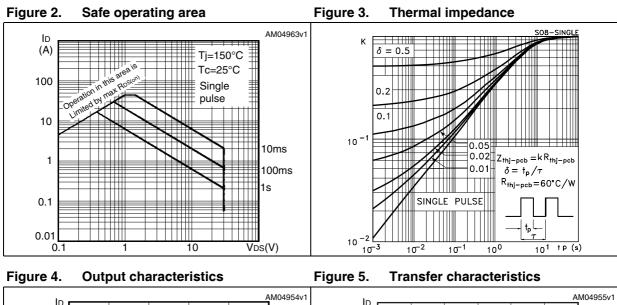
Symbol	Parameter	Test conditions	Min	Тур.	Max	Unit
I <sub>SD</sub>	Source-drain current		-		10	А
I <sub>SDM</sub> <sup>(1)</sup>	Source-drain current (pulsed)		-		40	А
V <sub>SD</sub> <sup>(2)</sup>	Forward on voltage	I <sub>SD</sub> = 10 A, V <sub>GS</sub> =0	-		1.1	V
t <sub>rr</sub>	Reverse recovery time	I <sub>SD</sub> = 10 A,		20.8		ns
Q <sub>rr</sub>	Reverse recovery charge	di/dt = 100 A/µs,	-	10.5		nC
I <sub>RRM</sub>	Reverse recovery current	V <sub>DD</sub> = 25 V, Tj=150 °C		1		А

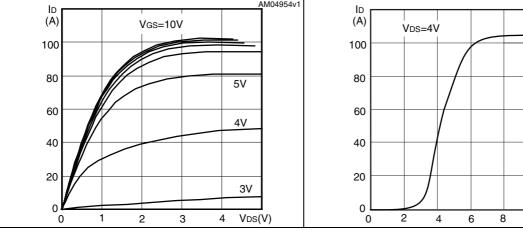
1. Pulse width limited by safe operating area

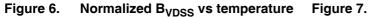
2. Pulsed: pulse duration=300µs, duty cycle 1.5%



## 2.1 Electrical characteristics (curves)

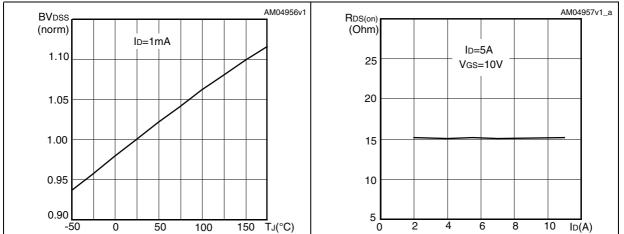




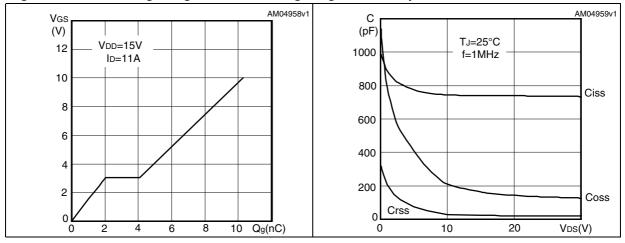


ure 7. Static drain-source on resistance

10 VGs(V)







#### Figure 8. Gate charge vs gate-source voltage Figure 9. Capacitance variations

Figure 10. Normalized gate threshold voltage Figure 11. Normalized on resistance vs vs temperature temperature

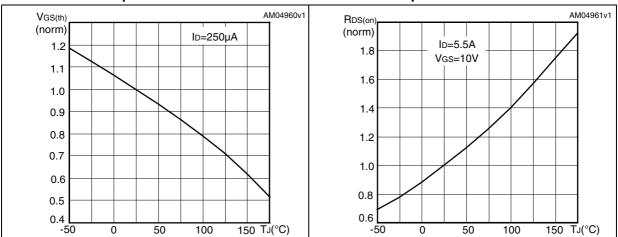
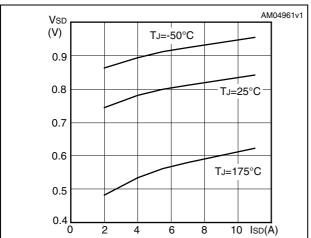


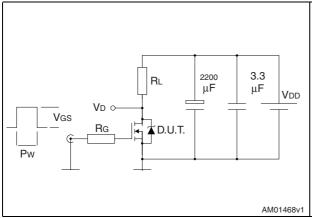
Figure 12. Source-drain diode forward characteristics



57

## 3 Test circuits

Figure 13. Switching times test circuit for resistive load



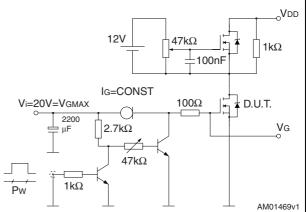
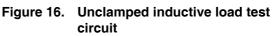
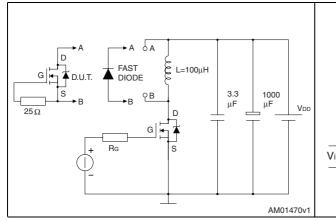
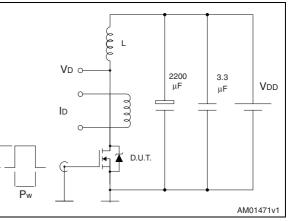


Figure 14. Gate charge test circuit

Figure 15. Test circuit for inductive load switching and diode recovery times







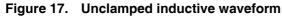
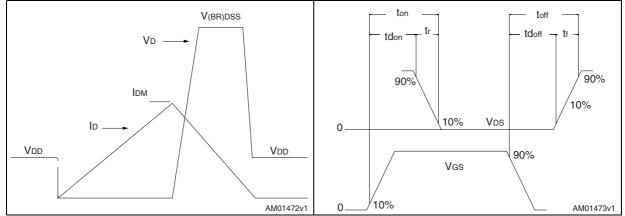


Figure 18. Switching time waveform



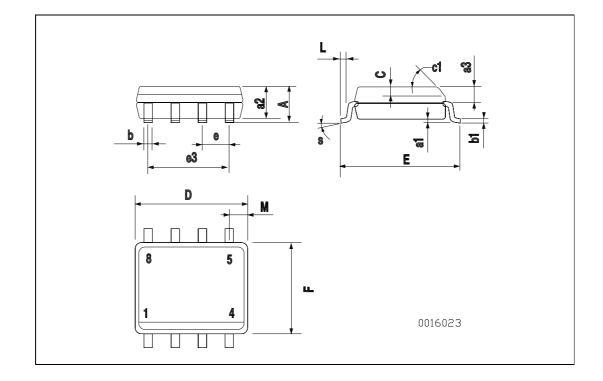


## 4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.



		SO-8 M	ECHANICA	L DATA		
DIM.		mm.			inch	
DIM.	MIN.	ТҮР	MAX.	MIN.	TYP.	MAX.
А			1.75			0.068
a1	0.1		0.25	0.003		0.009
a2			1.65			0.064
a3	0.65		0.85	0.025		0.033
b	0.35		0.48	0.013		0.018
b1	0.19		0.25	0.007		0.010
С	0.25		0.5	0.010		0.019
c1		•	45 (	(typ.)		
D	4.8		5.0	0.188		0.196
E	5.8		6.2	0.228		0.244
е		1.27			0.050	
e3		3.81			0.150	
F	3.8		4.0	0.14		0.157
L	0.4		1.27	0.015		0.050
М			0.6			0.023
S			8 (n	nax.)	1	1



Doc ID 16967 Rev 1



## 5 Revision history

#### Table 8. Document revision history

Date	Revision	Changes
12-Jan-2010	1	First release



#### Please Read Carefully:

Information in this document is provided solely in connection with ST products. STMicroelectronics NV and its subsidiaries ("ST") reserve the right to make changes, corrections, modifications or improvements, to this document, and the products and services described herein at any time, without notice.

All ST products are sold pursuant to ST's terms and conditions of sale.

Purchasers are solely responsible for the choice, selection and use of the ST products and services described herein, and ST assumes no liability whatsoever relating to the choice, selection or use of the ST products and services described herein.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted under this document. If any part of this document refers to any third party products or services it shall not be deemed a license grant by ST for the use of such third party products or services, or any intellectual property contained therein or considered as a warranty covering the use in any manner whatsoever of such third party products or services or any intellectual property contained therein.

UNLESS OTHERWISE SET FORTH IN ST'S TERMS AND CONDITIONS OF SALE ST DISCLAIMS ANY EXPRESS OR IMPLIED WARRANTY WITH RESPECT TO THE USE AND/OR SALE OF ST PRODUCTS INCLUDING WITHOUT LIMITATION IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION), OR INFRINGEMENT OF ANY PATENT, COPYRIGHT OR OTHER INTELLECTUAL PROPERTY RIGHT.

UNLESS EXPRESSLY APPROVED IN WRITING BY AN AUTHORIZED ST REPRESENTATIVE, ST PRODUCTS ARE NOT RECOMMENDED, AUTHORIZED OR WARRANTED FOR USE IN MILITARY, AIR CRAFT, SPACE, LIFE SAVING, OR LIFE SUSTAINING APPLICATIONS, NOR IN PRODUCTS OR SYSTEMS WHERE FAILURE OR MALFUNCTION MAY RESULT IN PERSONAL INJURY, DEATH, OR SEVERE PROPERTY OR ENVIRONMENTAL DAMAGE. ST PRODUCTS WHICH ARE NOT SPECIFIED AS "AUTOMOTIVE GRADE" MAY ONLY BE USED IN AUTOMOTIVE APPLICATIONS AT USER'S OWN RISK.

Resale of ST products with provisions different from the statements and/or technical features set forth in this document shall immediately void any warranty granted by ST for the ST product or service described herein and shall not create or extend in any manner whatsoever, any liability of ST.

ST and the ST logo are trademarks or registered trademarks of ST in various countries.

Information in this document supersedes and replaces all information previously supplied.

The ST logo is a registered trademark of STMicroelectronics. All other names are the property of their respective owners.

© 2010 STMicroelectronics - All rights reserved

STMicroelectronics group of companies

Australia - Belgium - Brazil - Canada - China - Czech Republic - Finland - France - Germany - Hong Kong - India - Israel - Italy - Japan -Malaysia - Malta - Morocco - Philippines - Singapore - Spain - Sweden - Switzerland - United Kingdom - United States of America

www.st.com

Doc ID 16967 Rev 1

